# imall

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We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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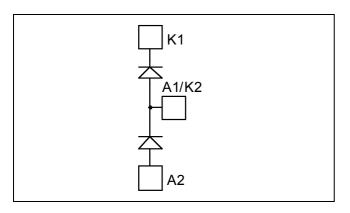
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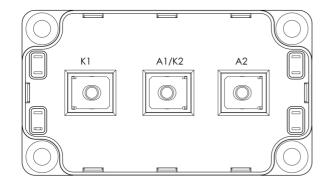




# APTDF400AK100G

# Diode Phase leg Power Module





#### Absolute maximum ratings

# $V_{RRM} = 1000V$ $I_{C} = 400A$ @ Tc = 70°C

#### Application

- Anti-Parallel diode
- Uninterruptible Power Supply (UPS)
- Induction heating
- Welding equipment
- High speed rectifiers

#### Features

- Ultra fast recovery times
- Soft recovery characteristics
- High blocking voltage
- High current
- Low leakage current
  - Very low stray inductance
  - Symmetrical design
  - M5 power connectors
- High level of integration

#### Benefits

- Outstanding performance at high frequency operation
- Low losses
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- RoHS Compliant

Symbol	Parameter			Max ratings	Unit		
V <sub>R</sub>	Maximum DC reverse Voltage				1000	V	
V <sub>RRM</sub>	Maximum Peak Repetitive Revers	e Voltage			1000	v	
I <sub>F(AV)</sub>	Maximum Average Forward	Dute male	- 500/	$T_C = 25^{\circ}C$	500		
	Current	Duty cycle	e = 50%	$T_{\rm C} = 25^{\circ}{\rm C}$ $T_{\rm C} = 70^{\circ}{\rm C}$	400	А	
I <sub>F(RMS)</sub>	RMS Forward Current	Duty cycle = 50%		$T_C = 45^{\circ}C$	500	11	
I <sub>FSM</sub>	Non-Repetitive Forward Surge Cu	rrent $8.3 \text{ms}$ $T_{\rm C} = 44$		$T_C = 45^{\circ}C$	3000		

CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on www.microsemi.com



### All ratings (a) $T_j = 25^{\circ}C$ unless otherwise specified

### **Electrical Characteristics**

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit	
$V_{\rm F}$	Diode Forward Voltage	$I_F = 400A$			2.1	2.7	
		$I_F = 600A$			2.3		V
		$I_{\rm F} = 400 {\rm A}$	$T_j = 125^{\circ}C$		1.7		
I <sub>RM</sub>	Maximum Reverse Leakage Current	$V_{\rm R} = 1000V$ $\frac{T_{\rm i} = 25^{\circ}{\rm C}}{T_{\rm j} = 125^{\circ}{\rm C}}$	$T_i = 25^{\circ}C$			250	
			$T_{j} = 125^{\circ}C$			1000	μA
C <sub>T</sub>	Junction Capacitance	$V_{R} = 1000V$			480		pF

### **Dynamic Characteristics**

Symbol	Characteristic	Test Conditions	Min	Тур	Max	Unit	
t <sub>rr</sub>	Reverse Recovery Time	$I_{F}=1A, V_{R}=30V$ di/dt = 400A/ $\mu$ s	$T_j = 25^{\circ}C$		45		ns
t <sub>rr</sub>	Reverse Recovery Time	-	$T_j = 25^{\circ}C$		290		ns
۲r	Reverse Recovery Time		$T_{j} = 125^{\circ}C$		340		115
Q <sub>rr</sub>	Reverse Recovery Charge	$I_{F} = 400A$ $V_{R} = 667V$ $di/dt = 800A/\mu s$	$T_j = 25^{\circ}C$		2.7		μC
Qπ	Reverse Recovery Charge		$T_{j} = 125^{\circ}C$		14.6		μΟ
I	Reverse Recovery Current	·····	$T_j = 25^{\circ}C$		24		А
I <sub>RRM</sub>	Reverse Recovery Current		$T_{j} = 125^{\circ}C$		72		А
t <sub>rr</sub>	Reverse Recovery Time	$I_F = 400A$ $V_R = 667V$ $di/dt = 4000A/\mu s$			160		ns
Qn	Reverse Recovery Charge		$T_j = 125^{\circ}C$		28.4		μC
I <sub>RRM</sub>	Reverse Recovery Current				280		А

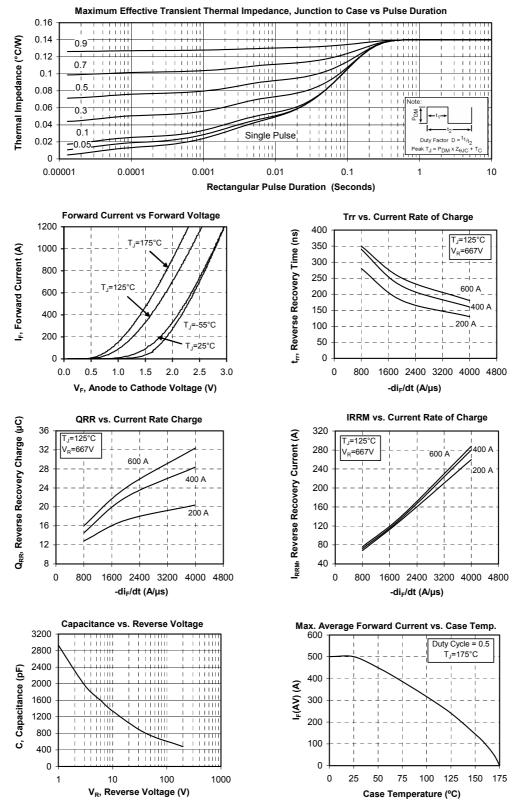
## Thermal and package characteristics

Symbol	Characteristic			Min	Тур	Max	Unit
R <sub>thJC</sub>	Junction to Case Thermal Resistance					0.14	°C/W
VISOL	RMS Isolation Voltage, any terminal to case t =1 min, 50/60Hz			4000			V
T <sub>J</sub>	Operating junction temperature range			-40		175	
T <sub>STG</sub>	Storage Temperature Range	mperature Range -40 125				°C	
T <sub>C</sub>	Operating Case Temperature					100	
Torque	Mounting torque	To heatsink	M6	3		5	N.m
	Woulding torque	For terminals	M5	2		3.5	19.111
Wt	Package Weight					300	g



# APTDF400AK100G

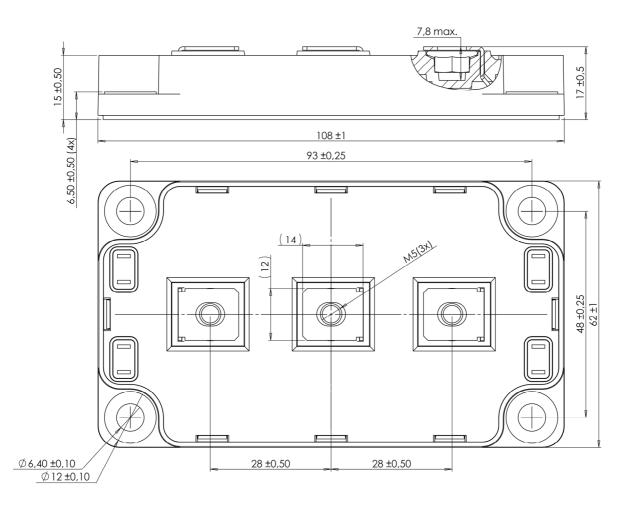
#### **Typical Performance Curve**



APTDF400AK100G-Rev 2 October, 2012



### SP6 Package outline (dimensions in mm)





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